IPC ASSOCIATION ELECTRONICS	Material Comp © Copyright 2005. international and Pa	IPC, Bannockl	ourn, Illinois. A	All rights reserved untions.		nent is a dec the declarat	laration ion enc	of the sub ompasses	stances v all lower	vithin the manufa- level materials fo	turer listed which the	item. Note: manufacture	if the item is an ager has engineering	ssembly with low responsibility.	
752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				Form Type * Distribute	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					erials and l	ials and Mfg Information			
upplier	Information														
Company name*				Company unique ID			Unique ID Authority					Response Date*			
nsemi											2023-0	2023-06-08			
Contact Na	me		Title - Contact			Phone - Contact*				Email	Email - Contact*				
Product-E	nv-Stewards		Product Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Repres				presentative J			Phone - Representative*				Email	Email - Representative*			
Product-Env-Stewards Pro				Product Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
	tequester Item Number Mfr Item		Number		Effective	ective Date   Version   Manufacturing Site			Weight*	UOM	Unit Type				
				driver with hall se	OR CLOSE; Three phase ensor method (closed loop	2023-06-0	08	РНМ			350.0	mg	Each		
Ianufac	turing Proccess Informa	tion													
7	Terminal Plating / Grid Array M	Terminal Base Alloy J-STD		J-STD-020 MSL Rating	Peak Process Body Te		Body Ter	nperature Max Time at Peak		ak Temper	ature Num	ber of Reflow Cy	cles		
c	contains Bi			CU Alloy 3		<b>260</b> C		30	seco	onds 3					
omments															
<b>LIENTIC</b>	ON: MSL 3 Rated item requir	es Bake and D	ry Pack (after	r electrical test)											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

<b>Homogeneous Material</b>	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	5.25	mg	Supplier	Silicon (Si)	7440-21-3		5.2306	mg
			Supplier	Polyimide	Proprietary Data		0.0194	mg
Die Attach	0.42	mg	Supplier	Silver (Ag)	7440-22-4		0.357	mg
			Supplier	Epoxy resins	129915-35-1		0.0567	mg
			Supplier	Polybutadiene polymer	Proprietary Data		0.0063	mg
Lead Frame	123.0	mg	Supplier	Zinc (Zn)	7440-66-6		0.2337	mg
			Supplier	Iron (Fe)	7439-89-6		3.1857	mg
			Supplier	Copper (Cu)	7440-50-8		119.4084	mg
			Supplier	Phosphorus (P)	7723-14-0		0.1722	mg
Mold Compound-Black	217.12	mg		Phenolic Resin	proprietary data		10.856	mg
			Supplier	Epoxy Phenol Resin	Proprietary Data		6.0794	mg
			Supplier	Carbon Black (C)	1333-86-4		2.1712	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		6.5136	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		173.696	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		17.3696	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		0.4342	mg
Plating	3.85	mg	В	Bismuth (Bi)	7440-69-9		0.0231	mg
			Supplier	Tin (Sn)	7440-31-5		3.8269	mg
Wire Bond - Cu	0.36	mg	Supplier	Copper (Cu)	7440-50-8		0.36	mg